

TFT-LCD PRODUCT SPECIFICATION

PART NUMBER:	USMP-TT043WT-01C
DESCRIPTION:	4.3" TFT LCD with 480 x 272 resolution,
	Digital 24-bits RGB Interface and 6 O'Clock Viewing Direction

ISSUE DATE	APPROVED BY	CHECKED BY	PREPARED BY
	(Customer Use Only)		
PROPRIETARY NOTE:	THIS SPECIFICATION IS THE PROPERTY O COPIED WITHOUT THE WRITTEN PERMI US MICRO		AND MUST BE RETURNED TO



History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
03/22/2010	01	001	New Drawing.	-	Lori
05/06/2010	01	002	New Sample.	-	Lori

Total: 26 Page



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1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	480 * 3 (RGB) * 272 Dots
LCD Type	a-Si TFT , Normally white, Transmissive type
Screen size(inch)	4.3 inch
Viewing Direction	6 O'clock
Color configuration	RGB-Strip
Backlight Type	LED B/L
Interface	Digital 24-bits RGB
Other(controller/driver IC)	OTA5180A (Or Compatible IC)

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	105.5(W) x 67.2 (L) x 5.0(H)MAX	mm

LCD panel

Item	Standard Value	Unit
Active Area	95.04 (W) x 53.856 (L)	mm

Touch panel

Item	Standard Value	Unit
Viewing Area	99.5 (W) * 58.0 (L)	mm
Active Area	97.0 (W) * 55.8 (L)	mm

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDDIO	GND=0	-0.3	4.5	V
Operating Temperature	T _{OP}	-	-20	70	°C
Storage Temperature	T _{ST}	-	-30	80	°C

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = 25°C

					•	
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	VDDIO	-	3.0	3.3	3.6	V
Input H/L Lovel Voltage	VIH	-	0.7VDDIO	-	VDDIO	V
Input H/L Level Voltage	VIL	-	0	-	0.3VDDIO	V
Output H/L Level	VOH	-	VDDIO-0.4	-	VDDIO	V
Voltage	VOL	-	0	-	GND+0.4	V
Supply Current	I _{DD}	VDDIO = 3.3 V Pattern=R/G/B/black *1	-	12	20	mA

Note1:Maximum current display



1.5 Optical Characteristics TFT LCD Module

VDDIO= 3.3 V, Ta=25°C

II I LOD MOddic							0.0 .	, ia 20 0
Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response time	Tr+Tf	25 ℃	-	-	30	45	ms	-
	Тор	θΥ+		45	55	-		
Viewing angle	Bottom	θΥ-	CD > 10	45	55	-	Dog	Note 4
viewing angle	Left	θX-	CR≥10 -	55	65	-	Deg.	Note 4
	Right	θX+		55	65	-		
Contrast ratio		CR		250	350	-	-	Note 3
	White	Х	Ta = 25°C θX , θY = 0°	0.24	0.29	0.34	-	
		Υ		0.28	0.33	0.38		
Color of CIE	Red	Х		0.52	0.57	0.62		
Color of CIE Coordinate		Υ		0.28	0.33	0.38		Note1
(With B/L)	Green	X		0.29	0.34	0.39		ivote i
(With b/L)		Υ		0.53	0.58	0.63		
	Blue	X		0.10	0.15	0.20		
	Diue	Υ		0.07	0.12	0.17		
Average Brightr	ness							
Pattern=white display		IV	IF= 20mA	200	240	-	cd/m2	Note1
(With LCD)*1								
Uniformity (With LCD)*:	2	△В	F= 20mA	70	-	-	%	Note1



Note 1:

*1 : △B=B(min) / B(max) * 100%

*2 : Measurement Condition for Optical Characteristics:

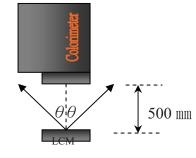
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





Colorimeter=BM-7 fast

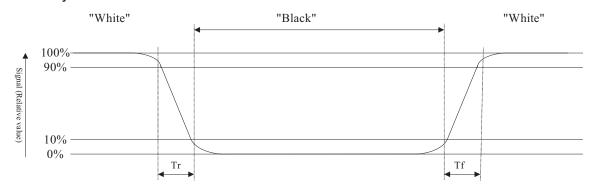
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

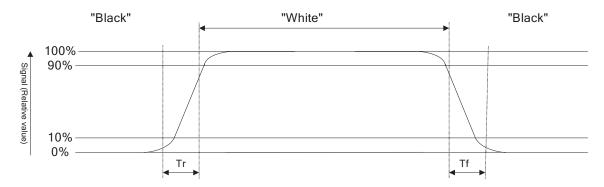
Refer to figure as below:

Normally White





Normally Black



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

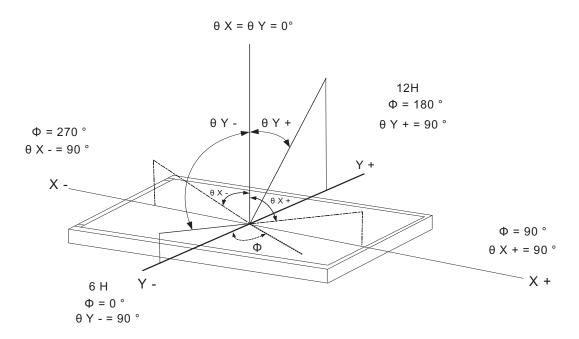
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

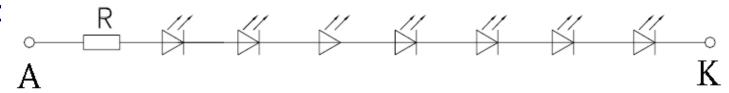
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
LED Forward Current	IF	Ta =25°ℂ	-	30	mA
LED Reverse Voltage	VR	Ta =25°ℂ	-	7	V
Power Dissipation	PD	Ta =25°ℂ	-	360	mW

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		-	22.8	-	V
Average Brightness (Without LCD &T/P)	IV	IF= 20mA	3300	4000	-	cd/m ²
CIE Color Coordinate	X		0.260	-	0.340	
(Without LCD &T/P)	Υ		0.260	-	0.340	-
Color			White	•		

Circuit diagram





1.7 Touch Panel Characteristics

1	Machanical property	Exclusive pen / Finger: 60~120g or below.					
'	Mechanical property	Pencil hardness : 3H or above.					
2	Ontical Duamants	Total light transmittance: 78% or above.					
2	Optical Property	Haze: 8% or below.					
		1. Operating Voltage: DC7V.					
		2. Circuit close resistance X: 260~1240 ohm.					
3	Electrical property	Y : 160~640 ohm.					
		3. Circuit open resistance : 20Mohm or above at 25V DC.					
		4. Contact bounce : 10 msec or below.					
4	Ctrusturo	Top Circuit: ITO FILM, Hard-coating, Thickness: 0.188mm.					
4	Structure	Bottom Circuit: ITO GLASS, Thickness: 0.7mm.					
		Operating Temperature: $-20^{\circ}\text{C} \sim 70^{\circ}\text{C}$.					
5	Canditions of was and started	(Operating Humidity: $20\% \sim 90\%$ non dew condensation).					
5	Conditions of use and storage	Storage Temperature: -30°C~80°C.					
		(Storage Humidity: 20%~90% non dew condensation).					



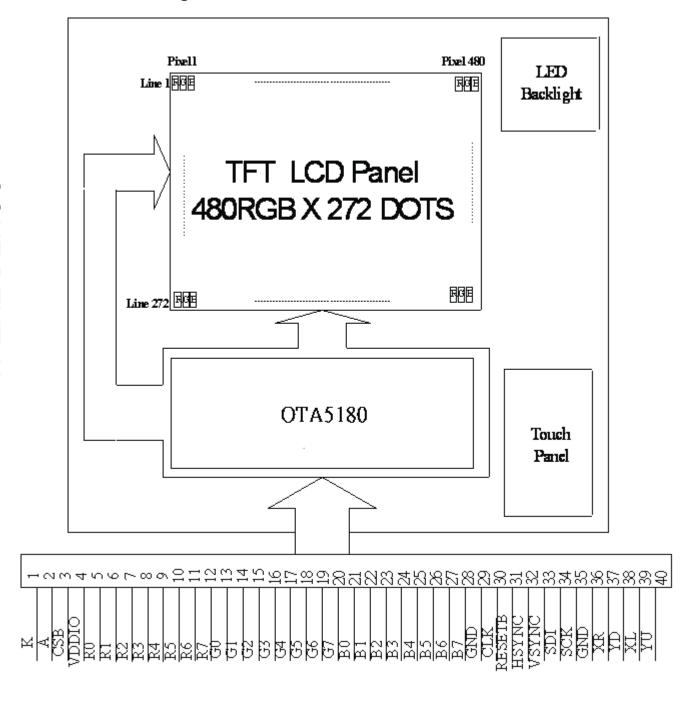
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function
1	K	Power supply for LED Backlight cathode input
2	А	Power supply for LED Backlight anode input
3	CSB	Chip select pin of serial interface.
4	VDDIO	Digital power
5	R0	Red data bit 0
6	R1	Red data bit 1
7	R2	Red data bit 2
8	R3	Red data bit 3
9	R4	Red data bit 4
10	R5	Red data bit 5
11	R6	Red data bit 6
12	R7	Red data bit 7
13	G0	Green data bit 0
14	G1	Green data bit 1
15	G2	Green data bit 2
16	G3	Green data bit 3
17	G4	Green data bit 4
18	G5	Green data bit 5
19	G6	Green data bit 6
20	G7	Green data bit 7



Pin No.	Symbol	Function
21	Symbol B0	Blue data bit 0
	-	
22	B1	Blue data bit 1
23	B2	Blue data bit 2
24	В3	Blue data bit 3
25	B4	Blue data bit 4
26	B5	Blue data bit 5
27	В6	Blue data bit 6
28	B7	Blue data bit 7
29	GND	Ground
30	CLK	Dot data clock
31	RESETB	Active low global reset signal input.
32	HSYNC	Horizontal sync input
33	VSYNC	Vertical sync input
34	SDI	Data input pin in serial interface.
35	SCL	Clock input pin in serial interface.
36	GND	Ground
37	XR	Right side of touch panel.
38	YD	Bottom side of touch panel.
39	XL	Left side of touch panel.
40	YU	Up side of touch panel.

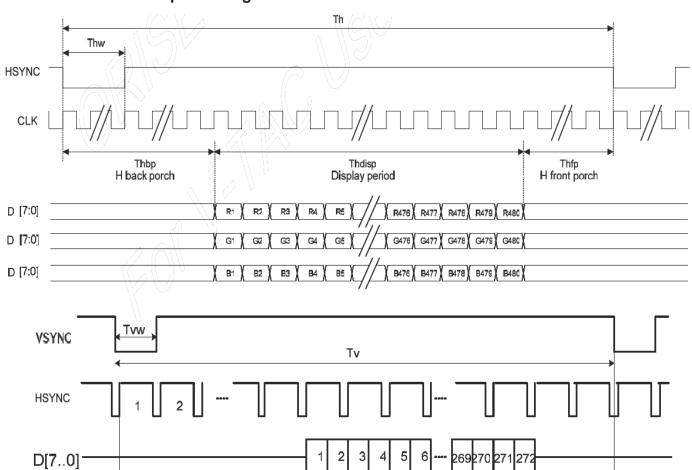


2.3 Timing Characteristics

2.3.1 Parallel RGB Input Timing Table

Tvbp

V back porch



	Item	Symbol	Min.	Тур.	Max.	Unit	
CLK F	Frequency	Fclk	5	9	12 🏈	MHz	
CLK	Period	Tclk	83	110	200	ns	
Hsync	Period Time	Th	490	531	605	DCLK	
	Display Period	Thdisp		480		DCLK	
	Back Porch	Thbp	8	43	//A,	DCLK	By H_BLANKING setting
	Front Porch	Thfp	2	8) "	DCLK	
	Pulse Width	Thw	1 /	\$ (A)\\ \\		DCLK	
Vsync	Period Time	Tv	275	288	335	Н	
	Display Period	Tvdisp	\ \	272		дН	
	Back Porch	Tvbp	2	12	1	Н	By V_BLANKING setting
	Front Porch	Tvfp	(P\\1\)	4		Н	
	Pulse Width	Tvŵ 🙈		10		\\	

Tvdisp

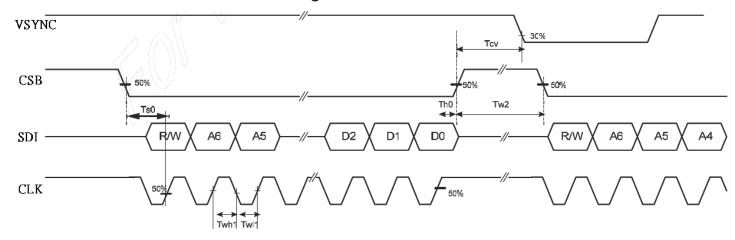
Display period

Tvfp

V front porch



2.3.2 3-Wire Communication Timing Table

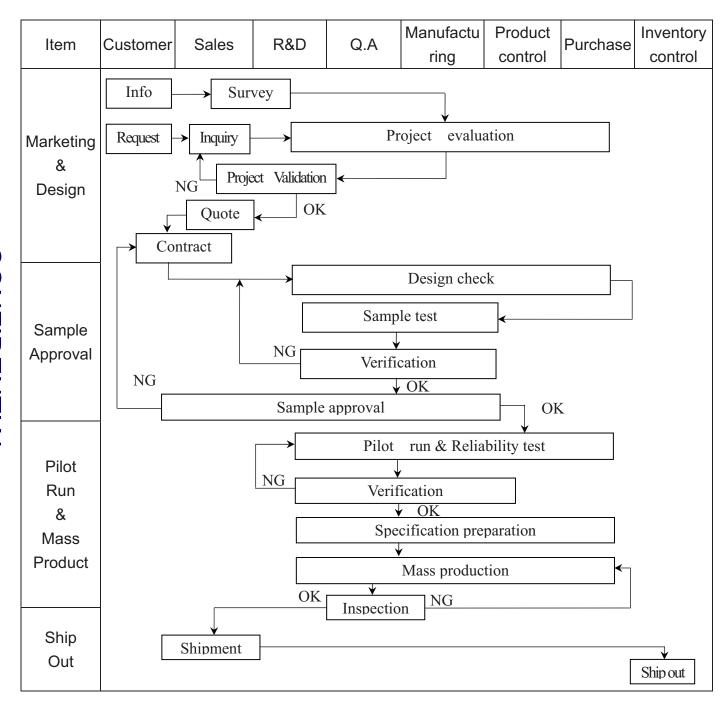


Serial communication							
Delay between CSB and Vsync	Tcv	1			us		
CS input setup time	Ts0	50			ns		
Serial data input setup time	Ts1	50			ns		
CS input hold time	Th0	50			ns		
Serial data input hold time	Th1	50			ns		
CLK pulse high width	Twh1	50			ns		
CLK pulse low width	Twl1	50			ns		
CS pulse high width	Tw2	400			ns		

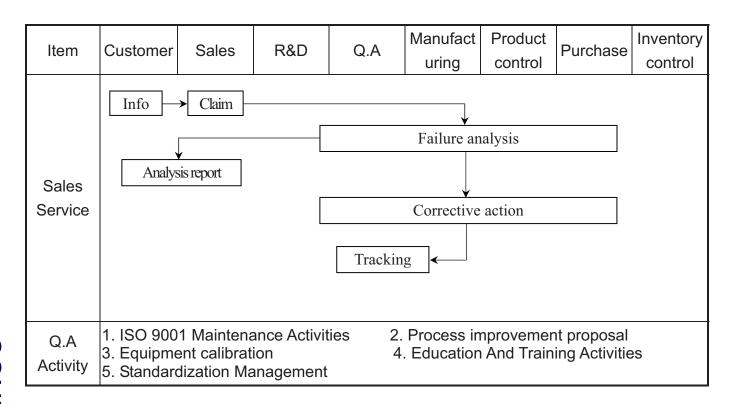


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart





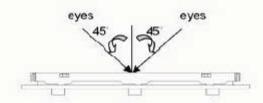




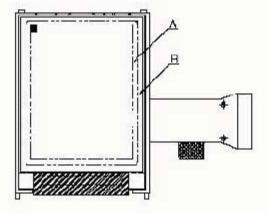
3.2 Inspection Specification

1. Inspection Specification

- ◆Scope : The document shall be applied to TFT-LCD Module for 3, 5" ~10" (Ver. 02).
- ♦ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.
- ◆Equipment: Gauge · MIL-STD · Sample
- ◆Defect Level: Major Defect AQL: 0.4 ; Minor Defect AQL: 1.5
- ♦OUT Going Defect Level: Sampling.
- Standard of the product appearance test :
 - a. Manner of appearance test
 - (1). The test best be under 20W×2 fluorescent light : and distance of view must be at 30 cm.
 - (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



▼Spe	cification For TFT-L	CD Modul	ì				Ver.B01)	
NO	Item		Criterion				Level	
		1. 1The part number is inconsistent with work order of production.					Major	
01	Product condition	1. 2 Mixe	d prod	uct types.			Major	
		1. 3 Asser	mbled i	n inverse direction.			Major	
02	Quantity	2. 1The q	uantity	is inconsistent with	work order of production	on.	Major	
03	Outline dimension		3. 1 Product dimension and structure must conform to structure diagram.					
	Electrical Testing	4. 1 Missi	ing line	character and icon.			Major	
		4. 2 No function or no display.					Major	
04		4. 3 Display malfunction.					Major	
		4. 4 LCD viewing angle defect.					Major	
		4. 5 Current consumption exceeds product specifications.					Major	
				Item	Acceptance (Q'ty)			
	Dot defect			Bright Dot	≦ 4			
			Dot	Dark Dot	≦ 5			
	(Bright dot \		Defect	Joint Dot	≦ 3			
05	Dark dot)			Total	≦ 7		Minor	
	On -display	5. 1 Inspe	5. 1 Inspection pattern: full white, full black, Red, Green and					
		blue screens.						
				as dot defect if defe				
		o. o i ne o	шѕіапс	e between two dot d	eiect ≤9 mm.			



NO	Item		Cri	terion			Level
NO 06	Black or white dot `scratch `contamination Round type → X ← Y Y T Line type ↓ W → L	0.25 <	(Non-display of Φ (diameter : Φ) $\Phi \le 0.25$ $\Phi \le 0.50$ $\Phi > 0.50$ Total On-display or diameter : Φ	display) Ac A an Igno splay): w) ≤ 0.03 ≤ 0.05	ceptance (Crea	Ignore Ignore	Minor
			Total	>0.10	type 5		
07	Polarizer Bubble	0.25 < 0.50 <	diameter : Φ) - $\Phi \le 0.25$ $\Phi \le 0.50$ $\Phi \le 0.80$ $\Phi > 0.80$	Ac A ar Igno	ore	Q'ty) B area Ignore	Minor



NO	Item	Criterion		Level
08	The crack of glass	Symbols: X: The length of crack Z: The thickness of crack	rick between panels: Y SP [NG]	Minor
		X Y	Z	
		≤ a Crack can't enter viewing area	≤1/2 t	
		≤ a Crack can't exceed the half of SP width.	$1/2 t < Z \leq 2 t$	



NO	Item	Criterion				Level	
		X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length					
		X	Y		Z		
		≤1/5 a	Crack can't e viewing are		≤ 1/2 t		
		≤1/5 a	Crack can't exce half of SP wid	1 / 7	$< Z \le 2 t$		
08	The crack of glass	8.2 Protrus	sion over termin	nal:		Minor	
		8. 2. 1 Chi	p on electrode	pad:			
		WY	X	X	Z		
			X	Y	Z		
		Front		≤ 1/2 W	≦ t		
		Back	≦ a	≦ W	$\leq 1/2 t$		



NO	Item	Criterion	Leve			
08	The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 2. 2 Non-conductive portion: $X = X = X = X = X = X = X = X = X = X =$	Min			
		the ITO must remain and be inspected according to electrode terminal specifications. 8. 2. 3 Glass remain: X				



NO	Item	Criterion	Level
		9. 1 Backlight can't work normally.	Major
09	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major
		9. 3 Illumination source flickers when lit.	Majoi
		10. 1 Pin type \ quantity \ dimension must match type in structure diagram.	Majoi
		10. 2 No short circuits in components on PCB or FPC .	Majo
10	General	10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Majo
10	appearance	10. 4 Product packaging must the same as specified on packaging specification sheet.	Mino
		10. 5 The folding and peeled off in polarizer are not acceptable.	Mino
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Mino



4. RELIABILITY TEST

4.1 Reliability Test Condition

=	4. 1	Reliability lest Collutton (vel.bu					
	NO.	TEST ITEM	TEST CO	ONDITION			
	1	High Temperature	Keep in +80 ±2°C 96 hrs				
	1	Storage Test	Surrounding temperature, then sto	orage at normal condition 4hrs.			
	2	Low Temperature	Keep in −30 ±2°C 96 hrs				
	4	Storage Test	Surrounding temperature, then sto	orage at normal condition 4hrs.			
		High Temperature /	Keep in $+60~^{\circ}$ C / 90% R.H duration	on for 96 hrs			
	3	High Humidity	Surrounding temperature, then sto	orage at normal condition 4hrs.			
		Storage Test	(Excluding the polarizer)				
			$-30^{\circ} \text{C} \rightarrow +25^{\circ} \text{C}$	→ +80°C → +25°C			
	4	Temperature Cycling	(30mins) (5mins)	(30mins) (5mins)			
	4	Storage Test	10 (Cycle			
			Surrounding temperature, then storage at normal condition 4hrs.				
\sum_{i}		ESD Test	Air Discharge:	Contact Discharge:			
<u> </u>			Apply 2 KV with 5 times	Apply 250 V with 5 times			
NEIDENTIA			Discharge for each polarity +/-	discharge for each polarity +/-			
_			1. Temperature ambiance : 15℃				
フ	5		2. Humidity relative : 30%~60%				
П			3. Energy Storage Capacitance(Cs+Cd): 150pF±10%				
			4. Discharge Resistance(Rd): 330 Ω±10%				
			5. Discharge, mode of operation :				
			Single Discharge (time between successive discharges at least 1 sec)				
ŀ			(Tolerance if the output voltage indication: ±5%)				
		Vibration Test	1. Sine wave $10 \sim 55$ Hz frequence	y (1 min/sweep)			
	6	(Packaged)	2. The amplitude of vibration :1.	5 mm			
-			3. Each direction (X \ Y \ Z) du	ration for 2 Hrs			
			Packing Weight (Kg)	Drop Height (cm)			
			0 ~ 45.4	122			
	_	Drop Test	45.4 ~ 90.8	76			
	7	(Packaged)	90.8 ~ 454	61			
			0ver 454	46			
			Drop Direction : 1 corner / 3 edg	es / 6 sides each 1time			



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

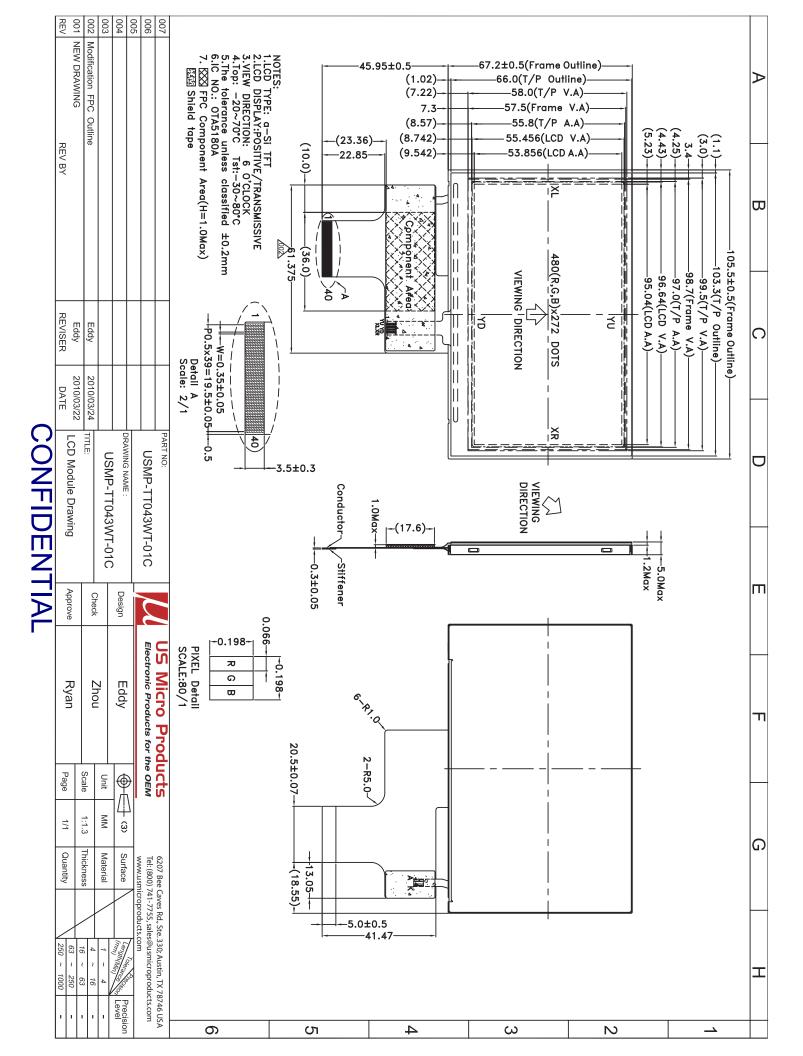
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



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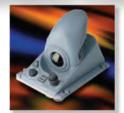
Peripheral Devices

Our full line of peripheral devices includes keyboards, trackballs, and printers. These rugged industrial products are designed to meet your demanding requirements and are available as both standard and custom solutions.

Trackballs Aerospace Trackballs

Keyboards





Joysticks



Printers

